1. Part No. Expression:

<u>PIAQ0503S1R0MN</u>

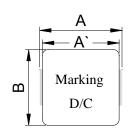
- (a)

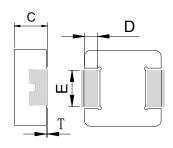
- (b) (c) (d) (e)(f)
- a) Series Code
- d) Inductance Code
- e) Tolerance Code
- c) Type Code

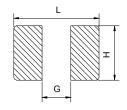
b) Dimension Code

f) Internal Controlled Code

2. Configuration & Dimensions:







Note:

Recommended PC Board Pattern

- 1. The above PCB layout is for reference only.
- 2. Solder paste thickness of 0.12mm and above is recommended.

 3. Marking: Top row Inductance code, Bottom row YYWW

Unit: mm

Α	A`	В	С	D	Е	Т	L	G	Н
5.7±0.3	5.2±0.3	5.2±0.2	2.8±0.2	1.0±0.3	2.0±0.2	0~0.15	6.0 Ref.	2.8 Ref.	2.5 Ref.

3. Schematic:



4. Material List:



- Core
- Wire
- Terminal
- d) Ink



5. General Specification:

(a) Reliability test for this part meets AEC-Q200 standard.

(b) Operating Temp.: -55°C to +155°C (Inclusive of coil temp rise).

(c) Storage Temp.: -55°C to +155°C (on board)...

(d) Humidity Range.: 85 ± 3% RH.

(e) Heat Rated Current (Irms) will cause the coil temperature rise approximately Δt of 40°C.

(f) Saturation Current (Isat) will cause L0 to drop approximately 30%.

(g) Part Temp. (Ambient + Temp. Rise) should not exceed 155°C under worst case operating conditions.

(h) Storage condition (component in its packaging)

i) Temperature: Less than 40°C

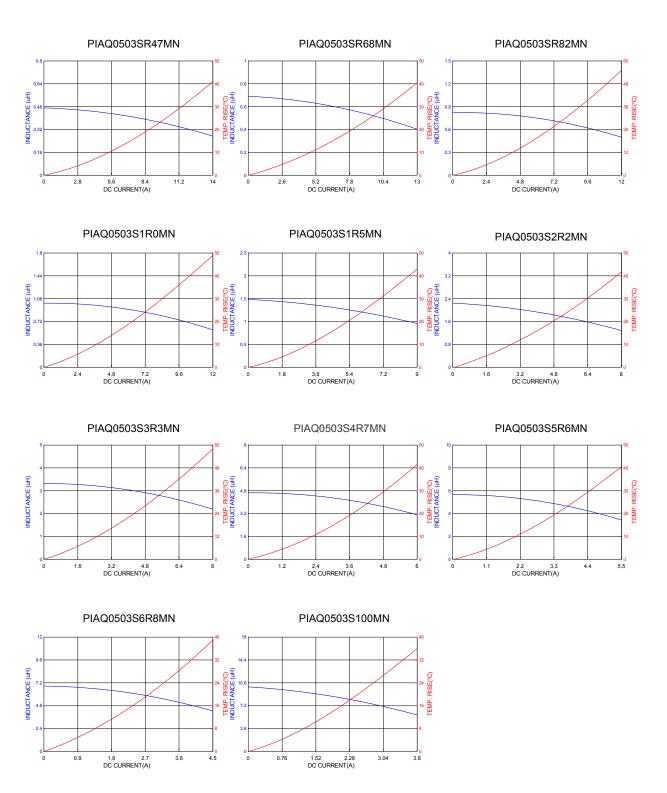
ii) Humidity: 60% RH

6. Electrical Characteristics:

Part Number	Inductance L (uH) ±20% @ 0A	Test Frequency (Hz)	Irms (A) Typ.	Irms (A) Max.	Isat (A) Typ.	Isat (A) Max.	DCR (mΩ) Typ.	DCR (mΩ) Max.
PIAQ0503SR47MN	0.47	1.0V/100K	13.5	12.0	10	9.0	5.2	6.0
PIAQ0503SR68MN	0.68	1.0V/100K	12.5	11.0	9.0	8.0	7.4	8.5
PIAQ0503SR82MN	0.82	1.0V/100K	10.0	9.0	8.8	7.7	8.0	9.2
PIAQ0503S1R0MN	1.00	1.0V/100K	9.0	8.0	8.5	7.5	10.5	12.0
PIAQ0503S1R5MN	1.50	1.0V/100K	8.0	7.0	7.5	6.5	13.6	15.7
PIAQ0503S2R2MN	2.20	1.0V/100K	7.0	6.5	6.5	5.8	21.6	25.0
PIAQ0503S3R3MN	3.30	1.0V/100K	6.3	5.8	6.0	5.3	28.0	33.0
PIAQ0503S4R7MN	4.70	1.0V/100K	5.5	4.8	5.3	4.6	38.0	44.0
PIAQ0503S5R6MN	5.60	1.0V/100K	5.0	4.3	4.6	4.0	50.0	58.0
PIAQ0503S6R8MN	6.80	1.0V/100K	4.3	3.7	3.5	3.1	57.0	66.0
PIAQ0503S100MN	10.0	1.0V/100K	3.8	3.4	2.5	2.1	88	103



7. Characteristics Curves:





8. Soldering:

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air.

8-1 Solder Re-flow

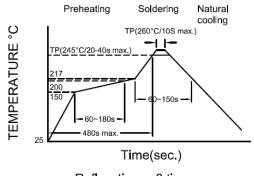
Recommended temperature profiles for re-flow soldering in Figure 1.

8-2 Soldering Iron (Figure 2)

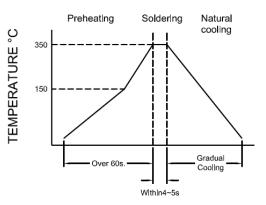
Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note:

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 secs.



Reflow times: 3 times max Fig.1



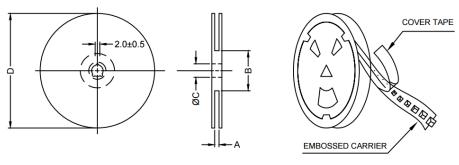
Iron Soldering times: 1 times max

Fig.2



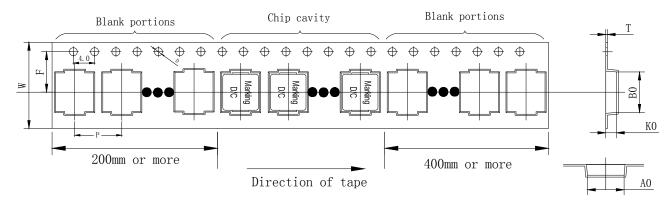
9. Packaging Information:

9-1 Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
13"x12mm	12.4+2/-0	100±2	13+0.5/-0.2	330

9-2 Tape Dimension



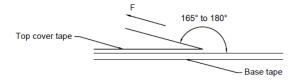
Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	T(mm)	D(mm)
PIAQ	0503	6.2±0.1	5.6±0.1	3.3±0.1	8.0±0.1	12.0±0.3	5.5±0.1	0.35±0.05	1.5±0.1

9-3 Packaging Quantity

PIAQ	0503		
Chip / Reel	2000		
Inner box	4000		
Carton	16000		



9-4 Tearing Off Force



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min	
5~35	45~85	860~1060	300	

Application Notice:

1. Storage Conditions:

To maintain the solderability of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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